



TE Internal #: 2-2129710-6
 TE Internal Description: RIGHT SIDE LGA3647-0 SOCKET-P0 FOR ODM
 LGA 3647 Sockets
[View on TE.com >](#)

Connectors > Socket Connectors > IC Sockets > LGA Sockets > LGA 3647 Sockets



IC Socket Type: **LGA 3647**
 Number of Positions: **1823**
 Contact Mating Area Plating Material Thickness: [30 µin]
 Centerline (Pitch): .86 mm, .99 mm [.034 in, .039 in]
 Termination Method to PCB: **Surface Mount - Solder Ball**

[All LGA 3647 Sockets \(0\)](#)

Features

Product Type Features

Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Positions	1823
Grid Spacing	.9906 x .8585 mm [.039 x .0338 in]

Body Features

Frame Style	C Shape
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Contact Features

Contact Mating Area Plating Material	Gold
Contact Base Material	Copper Alloy
IC Socket Type	LGA 3647
	30 µin
Contact Current Rating (Max)	.5 A

Termination Features

Termination Method to PCB	Surface Mount - Solder Ball
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Mechanical Attachment



Connector Mounting Type	Board Mount
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Housing Features

Housing Material	High Temperature Thermoplastic
Housing Color	Black
Centerline (Pitch)	.86 mm, .99 mm [.034 in] [.039 in]

Usage Conditions

Operating Temperature Range	-25 – 100 °C [-13 – 212 °F]
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Operation/Application

Circuit Application	Signal
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Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Tray Color	Blue
Packaging Method	Tray

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits

as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



TE Part # CAT-L59017-A76H
LGA 3647 Socket Hardware



TE Part # 2-2129710-5
LEFT SIDE LGA3647-0 SOCKET-P0 FOR ODM



TE Part # 2299806-1
NRW NON-FABRIC CARRIER, SOCKET P0



TE Part # 2305234-1
SOCKET P HARDWARE DUST COVER



TE Part # 2310927-1
CARRIER, NARROW FABRIC, SOCKET P



TE Part # 2821722-2
IFP/LEC CBL ASSY 1 PORT TYPE B STR INV



TE Part # 2821722-3
IFP/LEC CBL ASSY 1 PORT TYPE B STR INV



TE Part # 2821722-4
IFP/LEC CBL ASSY 1 PORT TYPE B STR INV

Customers Also Bought



TE Part # 5177985-5
0.8FH,R05H.5,120,08/Sn,TR,SC



TE Part # 2-5177986-5
0.8FH,P07H.5,120,08/Sn,TR,SC



TE Part # 1-1734037-0
Champ 050 series 100pos,Au over PdNi




TE Part # 1-2324271-2
LEFT SEGMENT LGA4189-4 SOCKET-P4 FOR ODM




TE Part # 2-2330552-2
ICX POINT PHM CARRIER ASSY, P4



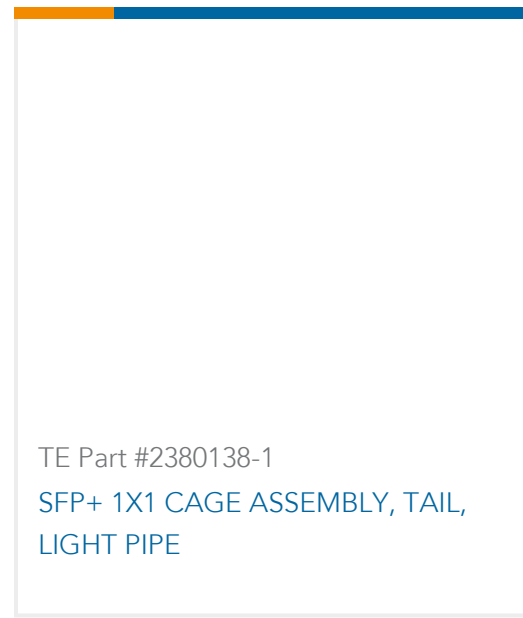
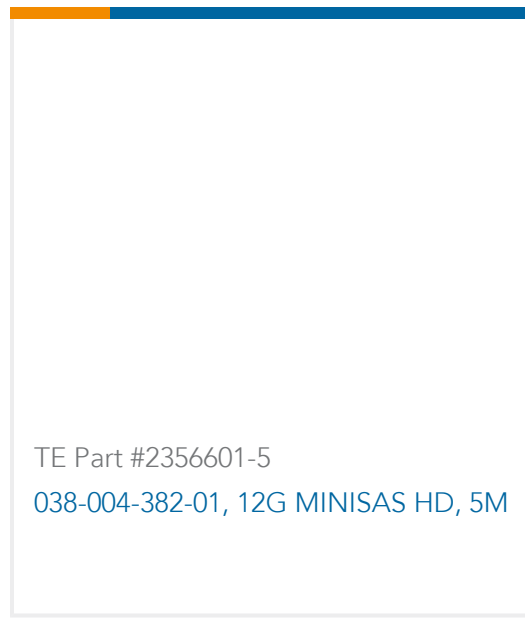
TE Part # 2-2129710-5
LEFT SIDE LGA3647-0 SOCKET-P0 FOR ODM



TE Part # 2187794-1
SW PIR RECT, 85OHM, 8X10



TE Part # 2199155-5
DDR4 DIMM 288 PIN SMT TYPE



Documents

Product Drawings

[RIGHT SIDE LGA3647-0 SOCKET-P0 FOR ODM](#)

English

CAD Files

[3D PDF](#)

3D

[Customer View Model](#)

[ENG_CVM_CVM_2-2129710-6_C.2d_dxf.zip](#)

English

[Customer View Model](#)

[ENG_CVM_CVM_2-2129710-6_C.3d_igs.zip](#)

English

[Customer View Model](#)

[ENG_CVM_CVM_2-2129710-6_C.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

[LGA 3647 Socket Product Flyer](#)

English

Product Specifications

[Application Specification](#)

English